

CRMKGL0602A

N-Channel 60V, 2.4mΩ Typ. Power MOSFET

Description



• 60V, 138A

 $R_{DS(ON)}$ Typ = 2.4m Ω @ V_{GS} = 10V

 $R_{DS(ON)}$ Typ = 3m Ω @ V_{GS} = 4.5V

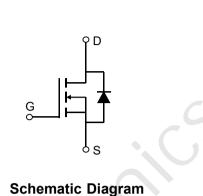
- Advanced Split Gate Trench Technology
- Excellent R_{DS(ON)} and Low Gate Charge
- 100% UIS TESTED!
- 100% ΔVds TESTED!

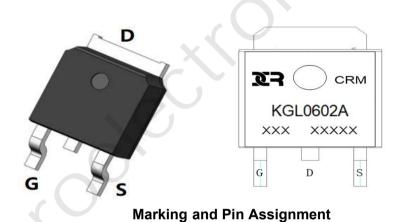
Application

PWM Application

• Power Management

· Load Switch



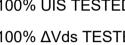


Package Marking and Ordering Information

Device	e Marking	Package	Outline	Reel Size	Reel (pcs)	Per Carton (pcs)		
CRMKGL06	602A CRMKGL0602A	TO-252-3L	TAPING	13"	2500	25000		

Absolute Maximum Ratings (@ T_J = 25°C unless otherwise specified)

Symbol	Parameter		Value	Units
V _{DS}	Drain-to-Source Voltage		60	V
V _{GS}	Gate-to-Source Voltage		±20	V
	Continuous Drain Current	$T_c = 25^{\circ}C$	138	А
Ι _D		T _C = 100°C	82.8	А
I _{DM}	Pulsed Drain Current ⁽¹⁾		552	А
E _{AS}	Single Pulsed Avalanche Energy ⁽²⁾		333	mJ
P _D	Power Dissipation	$T_c = 25^{\circ}C$	104	W
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case		1.2	°C/W
Τ _J , Τ _{stg}	Junction & Storage Temperature Range		-55 to 150	°C





Electrical Characteristics (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Uni
Off Chara	acteristics					
V _{(BR)DSS}	Drain-Source Breakdown Voltage	I _D = 250μA, V _{GS} = 0V	60	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 60V, V _{GS} = 0V	-	-	1.0	μA
I _{GSS}	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA
On Chara	acteristics				G	
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1.2	1.8	2.4	V
R _{DS(ON)}	Static Drain-Source ON-Resistance ⁽³⁾	V _{GS} = 10V, I _D = 30A	-	2.4	3.1	mΩ
		V _{GS} = 4.5V, I _D = 20A	-	3	3.9	mΩ
Dynamic	Characteristics					
C _{iss}	Input Capacitance		-	4470	-	pF
C _{oss}	Output Capacitance	V _{GS} = 0V, V _{DS} = 30V, f = 1MHz	Χ-	1096	-	pF
C _{rss}	Reverse Transfer Capacitance	1 - 110112	-	14	-	pF
Qg	Total Gate Charge	0	<u> </u>	65	-	nC
Q_{gs}	Gate Source Charge	$V_{GS} = 0$ to 10V $V_{DS} = 30V$, $I_{D} = 50A$	-	28	-	nC
Q_{gd}	Gate Drain("Miller") Charge	$v_{\rm DS} = 30 v$, $v_{\rm D} = 30 A$	-	4	-	nC
Switchin	g Characteristics					
t _{d(on)}	Turn-On DelayTime		-	16	-	ns
t _r	Turn-On Rise Time	V _{GS} = 10V, V _{DD} = 30V	-	30	-	ns
$t_{d(off)}$	Turn-Off DelayTime	I_{D} = 50A, R_{GEN} = 2.7 Ω	-	43	-	ns
t _f	Turn-Off Fall Time		-	18	-	ns
Drain-So	urce Diode Characteristics and M	lax Ratings				
I _s	Maximum Continuous Drain to Source Diode Forward Current		-	-	138	А
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current		-	-	552	А
V_{SD}	Drain to Source Diode Forward Voltage	$V_{GS} = 0V, I_{S} = 30A$	-	-	1.2	V
trr	Body Diode Reverse Recovery Time		-	43	-	ns
Qrr	Body Diode Reverse Recovery Charge	I _F = 50A, di/dt = 100A/us	-	50	-	nC

Notes:

1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

2. E_{AS} condition: Starting T_J =25°C, V_{DD} =30V, V_G =10V, R_G =25ohm, L=0.5mH, I_{AS} =36.5A

3. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 0.5%.



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Test Circuit

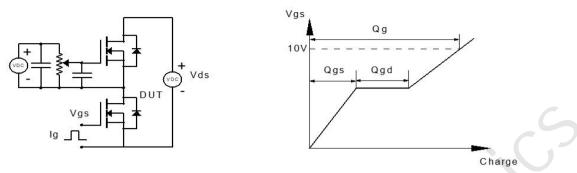


Figure 1: Gate Charge Test Circuit & Waveform

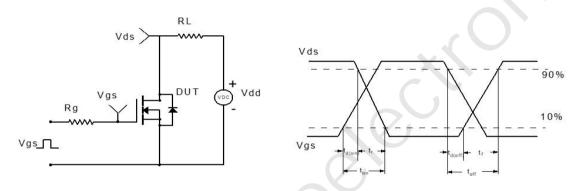


Figure 2: Resistive Switching Test Circuit & Waveform

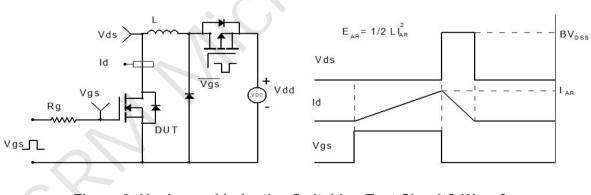


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

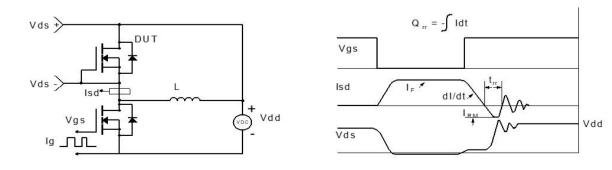
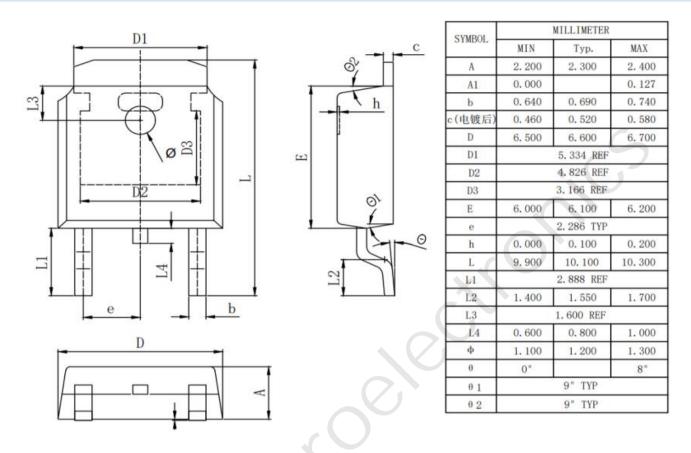


Figure 4: Diode Recovery Test Circuit & Waveform



Package Mechanical Data(TO-252-3L)



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